BP1042 70 MHz SAW Filter



- Designed for CDMA Receiver IF Applications
- Simple External Impedance Matching
- Hermetic Metal DIP
- Unbalanced Input and Output
- Complies with Directive 2002/95/EC (RoHS)





See Associated Plots

Characteristic	Sym	Min	Тур	Max	Units	Notes
Nominal Center Frequency	fc		70.000		MHz	1
Passband Insertion Loss at fo	IL		22	28	dB	
1 dB Passband		±455	±500		kHz	1, 2
3 dB Passband	BW ₃	±550	±600			
Group Delay Variation over fc ±550 kHz	GDV		150	175	ns _{P-P}	
Phase Linearity over fc ±550 kHz			4	5	°P-P	
Rejection At fc ±1.0 MHz		40	45		dB	1, 2, 3
Ultimate from 1 MHz to 105 MHz		40	50			
Operating Temperature Range	T _A	-25		+85	°C	1

Impedance Matching to 50 Ω unbalanced	External L-C
Suggested Matching Network Impedance at Port 1	375 nH in parallel with 310 Ω
Suggested Matching Network Impedance at Port 2	240 nH in parallel with 320 Ω
Case Style	DIP14L-8 22.1 x 12.6 mm Nominal Footprint
Lid Symbolization (RR = run code, LL = lot code)	RFM BP1042 RRLL

Absolute Maximum Ratings

Rating	Value	Units			
Maximum Incident Power in Passband	+10	dBm			
Max. DC voltage between any 2 terminals	30	VDC			
Storage Temperature Range	-40 to +85	°C			
Max Soldering Temperature 260°C for 30 s					
Suitable for lead-free Soldering					

Electrical Connections (See note 3)

Connection	Terminals
Port 1 Hot	7
Port 1 Gnd Return	9
Port 2 Hot	14
Port 2 Gnd Return	2
No Connection	1, 8
Case Ground	2, 9 & All others

Notes:

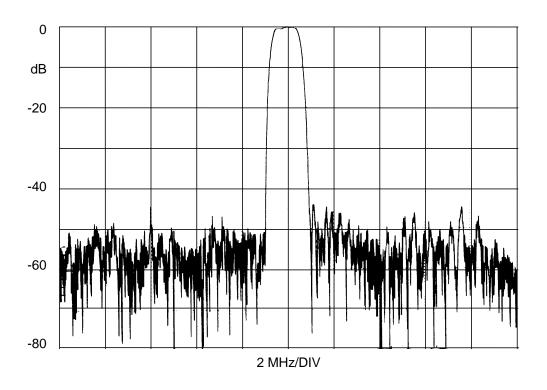
- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
- 2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
- 3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details. All "NC" or "no connection pins should be grounded.
- 4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
- 5. The design, manufacturing process, and specifications of this filter are subject to change.
- 6. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
- 7. US and international patents may apply.
- 8. RFM, stylized RFM logo, and RF Monolithics, Inc. are registered trademarks of RF Monolithics, Inc.
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- 10. Electrostatic Sensitive Device. Observe precautions for handling.

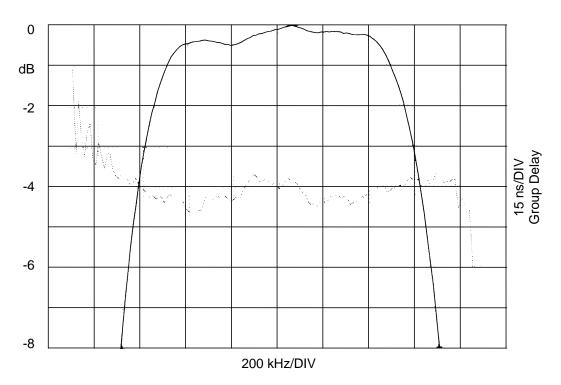


RF Monolithics, Inc. 4441 Sigma Road Dallas, Texas 75244 USA Phone: +1(972)233-2903 Fax: +1(972)387-8148 e-mail: <u>info@rfm.com</u> Home page: www.rfm.com

European Sales Office 44 1963 251383 44 1963 251510







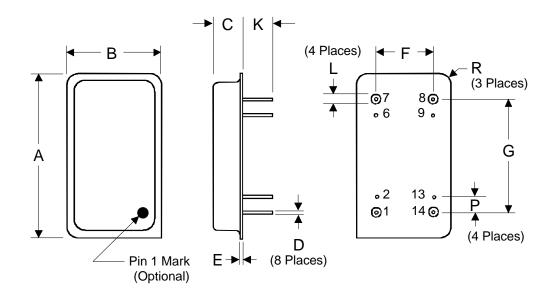
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Metal 8-Pin DIP in 14-Pin (Long) Configuration 22.1 x 12.6 mm Nominal Footprint



Dimension	mm			Inches			
Diffiction	Min	n Nom Max		Min	Nom	Max	
Α		22.10	22.50		0.870	0.886	
В		12.55	13.00		0.494	0.512	
С		3.56	3.81		0.140	0.150	
D	0.41	0.48	0.51	0.016	0.019	0.020	
Е		0.89			0.035		
F		7.62			0.300		
G		15.24			0.600		
K	3.30	3.81	6.73	0.130	0.150	0.265	
L	1.37	1.45	1.52	0.054	0.057	0.060	
Р		2.54			0.100		
R		1.60			0.063		



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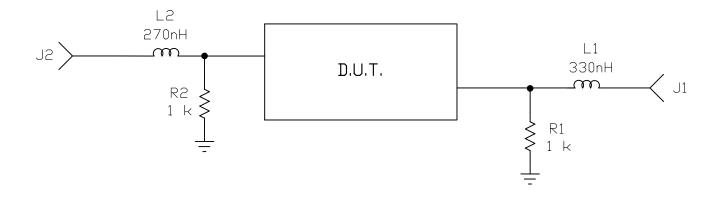
REV	ECN NO.	DESCRIPTION	APP/DATE
А	4571	INITIAL RELEASE	

BILL OF MATERIALS

SEQ	QTY	RFM P/N	DESCRIPTION	REF DES	REFERENCE/ COMMENTS
1	1	400-0846-001	14 PIN PCB	РСВ	
2	2	500-0248-001	CONN, COAX, FLANGE MT. JACK	J1,2	
3	1	500-0010-331	IND, CHIP 330 nH	L1	±10%,
4	1	500-0010-271	IND, CHIP 270 nH	L2	±10%,
5	2	500-0127-102	RES, C.COMP, 1.0 k, .25W	R1,2	±5%

DRAWN BY/DATE: J. LA	TON 05/01/96	TITLE:	TITLE: DEMO PCB, BP1042				
RF Monolithics, II DALLAS, TEXAS 75244	CHECKED/APPROVED	SIZE A	code ident 2U874	DWG. NO.	BP1042(DEMO)	rev A	SHEET 1/7

SCHEMATIC, BP1042 (DEMD)



RF Monolithics, Inc. DALLAS, TEXAS 75244

SIZE Α

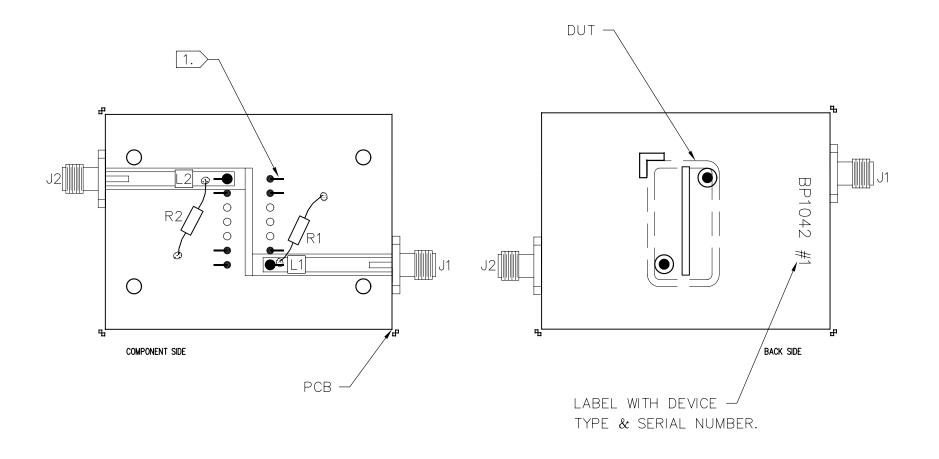
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SHEET REV Α

2

1. DEVICE LEADS ARE TO BE SOLDERED DIRECTLY TO PCB. (NO PIN SOCKETS ARE USED)



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REV S

SHEET 3

INSTRUCTIONS:

PLOTS: PLOTS A & B SHOW PLACE ON SMITH CHART WHERE DEVICE IS TO BE TUNED TO.

PLOT #C IS TO BE DELIVERED WITH EACH DEMO.

THE TUNING COMPONENT VALUES MAY VARY IN ORDER TO ACHIEVE PROPER TUNING

DUE TO COMPONENT TOLERANCES. NOTE COMPONENT VALUES AND TOLERANCES ON EACH PLOT.

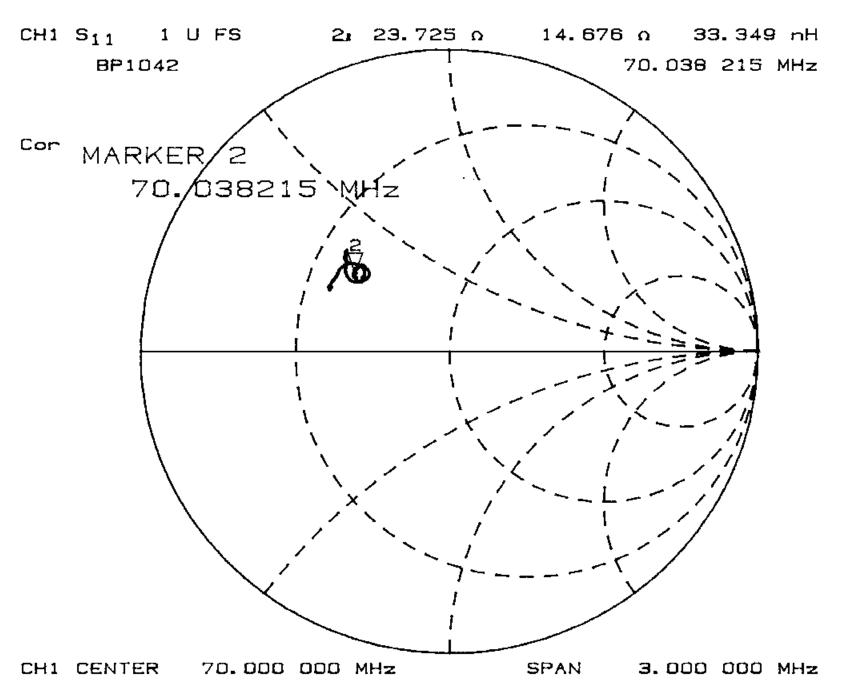
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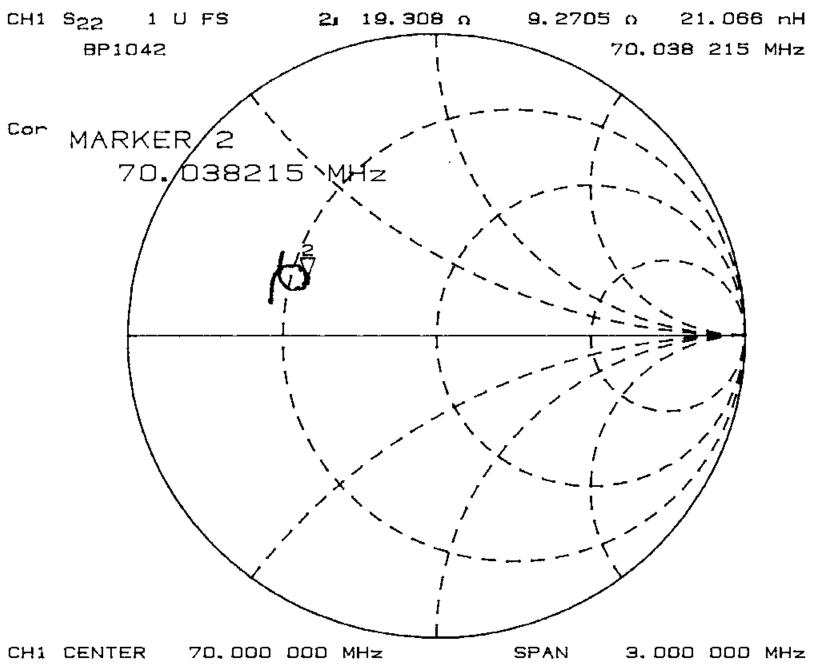
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REV A SHEET 4



Sheet 5 08 7 Rev: A



Sheet 6 of 7 REVIA